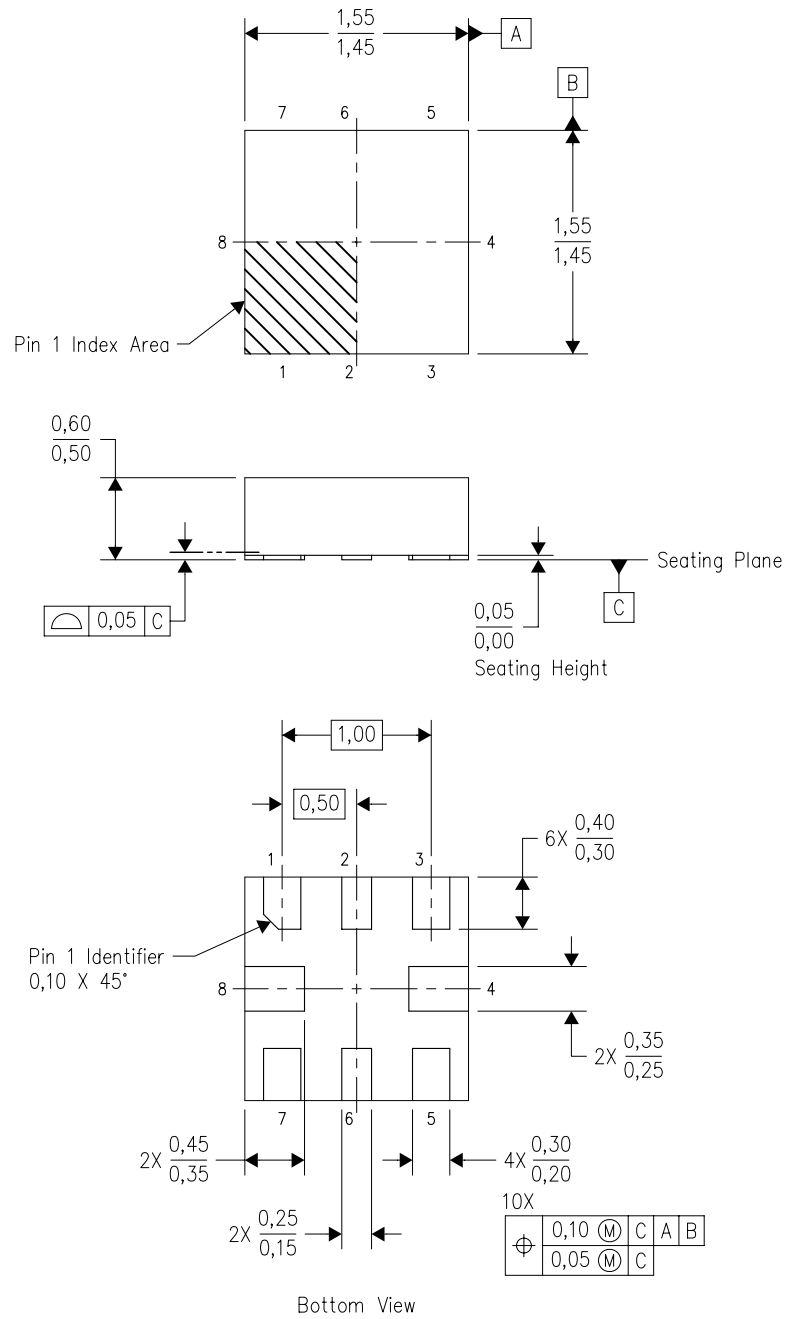


RSE (S-PUQFN-N8)

PLASTIC QUAD FLATPACK NO-LEAD



4207268-2/D 01/11

- NOTES:
- All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - This drawing is subject to change without notice.
 - QFN (Quad Flatpack No-Lead) package configuration.
 - This package complies to JEDEC MO-288 variation UECD.

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